

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>You-Hua CHOU</td> <td>04/27/2012</td> </tr> <tr> <td>Chih-Tsung LEE</td> <td>04/27/2012</td> </tr> <tr> <td>Shu-Fen WU</td> <td>04/27/2012</td> </tr> <tr> <td>Chin-Hsiang LIN</td> <td>04/27/2012</td> </tr> </tbody> </table>	Name	Execution Date	You-Hua CHOU	04/27/2012	Chih-Tsung LEE	04/27/2012	Shu-Fen WU	04/27/2012	Chin-Hsiang LIN	04/27/2012	
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Shu-Fen WU	04/27/2012										
Chin-Hsiang LIN	04/27/2012										
RECEIVING PARTY DATA											
Name:	Taiwan Semiconductor Manufacturing Co., Ltd.										
Street Address:	No. 8, Li-Hsin Road 6										
Internal Address:	Science-Based Industrial Park										
City:	Hsin-Chu										
State/Country:	TAIWAN										
Postal Code:	300-77										
PROPERTY NUMBERS Total: 1											
Property Type	Number										
Application Number:	13460884										
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ATTORNEY DOCKET NUMBER:	2011.1453/1085.971										
NAME OF SUBMITTER:	Frank J. Spanitz										
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Serial No. 13/460,884  
filed May 1, 2012

**ATTORNEY DOCKET NO.: 2011.1453 /1085.971**

**ASSIGNMENT AND AGREEMENT**

For value received, We, **You-Hua CHOU, Chih-Tsung LEE, Shu-Fen WU and Chin-Hsiang LIN**, hereby transfers to **Taiwan Semiconductor Manufacturing Co., Ltd.**, with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **SEMICONDUCTOR FILM FORMATION APPARATUS AND PROCESS**, described in a non-provisional application claiming priority thereto and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: April 27, 2012

Yow-Hua Chou  
Yow-Hua CHOU

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Dated: April 27, 2012

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Inventor No. 3

Dated: April 27, 2012

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Inventor No. 4

Dated: 4.27.2012

  
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